

### SHARP

#### SYSTEM DEVICE DIVISION I ELECTRONIC COMPONENTS AND DEVICES GROUP SHARP CORPORATION

### **SPECIFICATION**

DEVICE SPECIFICATION FOR	
PHOTOCOUPLE MODEL No.	ER
PC852	
Business dealing	gname
PC852XNNIP0F	PC852XNYIP0F
Specified for	
Enclosed please find copies of the Specifications which c This specification sheets and attached sheets shall be both After confirmation of the contents, please be sure to send with approving signature on each.	n side copy.
CUSTOMER'S APPROVAL	PRESENTED
DATE	DATE
BY	BY M. Makus
	M. Kubo, Department General Manager of Development Dept. IV System Device Div. I Electronic Components and Devices Group SHARP CORPORATION

## REFC852RVEPOLCE

Product name: PHOTOCOUPLER

Model No.: PC852

Business dealing name			
PC852XNNIP0F	PC852XNYIP0F		

- I. These specification sheets include materials protected under copyright of Sharp Corporation ("Sharp"). Please do not reproduce or cause anyone to reproduce them without Sharp's consent.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets, and the precautions mentioned below.

(Precautions)

- (1) Please do verify the validity of this part after assembling it in customer's products, when customer wants to make catalogue and instruction manual based on the specification sheet of this part.
- (2) This product is designed for use in the following application areas;
  - OA equipment · Audio visual equipment · Home appliances
  - · Telecommunication equipment (Terminal) · Measuring equipment
  - · Tooling machines · Computers

If the use of the product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when this product is used for equipment which demands high reliability and safety in function and precision, such as;
  - Transportation control and safety equipment (aircraft, train, automobile etc.)
  - · Traffic signals · Gas leakage sensor breakers · Rescue and security equipment
  - Other safety equipment
- (4) Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as;
  - · Space equipment · Telecommunication equipment (for trunk lines)
  - · Nuclear power control equipment · Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any questions regarding interpretation of the above four paragraphs.
- 3. Please contact and consult with a Sharp sales representative for any questions about this product.

# REFERENCE CE

1. Application

This specification applies to the outline and characteristics of photocoupler Model No. PC852 (Lead-Free Type).

2. Outline Refer to the attached sheet, page 4.

3. Ratings and characteristics Refer to the attached sheet, page 5, 6.

4. Reliability Refer to the attached sheet, page 7.

5. Outgoing inspection Refer to the attached sheet, page 8.

#### 6. Supplement

- 6.1 Isolation voltage shall be measured in the following method.
- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The dielectric withstanding tester with zero-cross circuit shall be used.
- (3) The wave form of applied voltage shall be a sine wave.

(It is recommended that the isolation voltage be measured in insulation oil.)

- 6.2 Package specifications Refer to the attached sheet, page 9, 10.
- 6.3 Collector current (Ic) Delivery rank table ("O" mark indicates business dealing name of ordered product)

Ordered	Business	Ordered	* Business
delivery	dealing name	delivery	dealing name
	PC852XNNIP0F		

<sup>\*</sup>Applied to products as option (Attachment 2-1 to 2-3)

6.4 This Model is approved by UL.

Approved Model No.: PC852

UL file No.: E64380

6.5 This product is not designed against irradiation.

This product is assembled with electrical input and output.

This product incorporates non-coherent light emitting diode.

#### 6.6 ODS materials

This product shall not contain the following materials.

Also, the following materials shall not be used in the production process for this product.

Materials for ODS : CFCs, Halon, Carbon tetrachloride, 1.1.1-Trichloroethane (Methyl chloroform)

#### 6.7 Specified brominated flame retardants

Specified brominated flame retardants (PBB and PBDE) are not used in this device at all.



#### 6.8 Compliance with each regulation

(1) The RoHS directive (2002/95/EC)

This product complies with the RoHS directive (2002/95/EC).

Object substances: mercury, lead, cadmium, hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE)

(2) Content of six substances specified in Management Methods for Control of Pollution Caused by Electronic Information Products Regulation (Chinese: 电子信息产品污染控制管理办法).

1 to dialong 1 to Butture.	(	<u> </u>	HH1 3>1<1-2-11-1	July 1000 100 100 100 100 100 100 100 100 1		
			Toxic	and hazardous su	ibstances	
Category	Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent chromium (Cr <sup>6+</sup> )	Polybrominated biphenyls (PBB)	Polybrominated diphenyl ethers (PBDE)
Photocoupler	<b>✓</b>	<b>✓</b>	<b>✓</b>	1	1	1

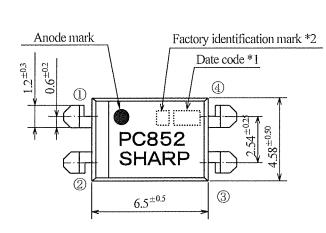
 $<sup>\</sup>checkmark$ : indicates that the content of the toxic and hazardous substance in all the homogeneous materials of the part is below the concentration limit requirement as described in SJ/T 11363-2006 standard.

#### 7. Notes

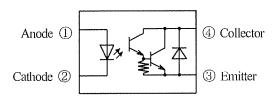
Precautions for photocouplers : Attachment-1

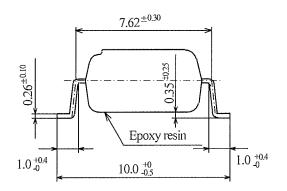
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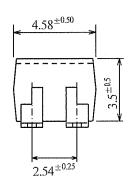
#### 2. Outline



Pin-Number and internal connection diagram







- \*1) 2-digit number shall be marked according to OLD DIN standard.
- \*2) Factory identification mark applies to the below.

: WUXI WONDERFUL ELECTRONICS CO., LTD. (China).

or : SUN-S Electronic Technology (KUNSHAN) Co., Ltd (China)

Pin material: Copper Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

Product mass: Approx.0.22g

UNIT : 1/1 mm

PC852 Outline Dimensions
Name (Business dealing name : PC852XNNIP0F)

Marking is laser marking

## REFERENCE

#### 3. Ratings and characteristics

#### 3.1 Absolute maximum ratings

Ta=25°C

	Parameter		Symbol	Rating	Unit
	*1	Forward current	$I_{\mathrm{F}}$	50	mA
Input	*2	Peak forward current	I <sub>FM</sub>	1	Α
		Reverse voltage	V <sub>R</sub>	6	V
	*1	Power dissipation	P	70	mW
		Collector-emitter voltage	V <sub>CEO</sub>	350	V
Output		Emitter-collector voltage	V <sub>ECO</sub>	0.1	V
g [		Collector current	I <sub>c</sub>	150	mA
	*1	Collector power dissipation	P <sub>c</sub>	150	mW
	*1	Total power dissipation	P <sub>tot</sub>	200	mW
		Operating temperature	Topr	-30 to +100	$^{\circ}\mathbb{C}$
		Storage temperature	T <sub>stg</sub>	-55 to +125	$\mathbb{C}$
	*3	Isolation voltage	V <sub>iso(ms)</sub>	5	kV
	*4 Soldering temperature		T <sub>sol</sub>	270	$^{\circ}\!\mathbb{C}$

#### 3.2 Electro-optical characteristics

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	Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit
	Forward voltage	$V_{\rm F}$	I <sub>F</sub> =10mA	-	1.2	1.4	V
Input	Reverse current	$I_R$	V <sub>R</sub> =4V	-	-	10	$\mu$ A
	Terminal capacitance	Ct	V=0, f=1kHz	-	30	250	рF
Output	Dark current	I <sub>CEO</sub>	V <sub>CE</sub> =200V, I <sub>F</sub> =0	-	-	200	nA
Output	Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>c</sub> =0.1mA, I <sub>F</sub> =0	350	-	-	V
	Collector current	$I_c$	I <sub>F</sub> =1mA, V <sub>CE</sub> =2V	10	40	150	mA
	Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>F</sub> =20mA, I <sub>c</sub> =100mA	-	-	I.2	V
Transfer	solation resistance	R <sub>ISO</sub>	DC500V 40 to 60%RH	5×10 <sup>10</sup>	1011	-	Ω
charac-	Floating capacitance	$C_{\mathrm{f}}$	V=0, f=1MHz	•••	0.6	1.0	рF
teristics	Cut-off frequency	f <sub>c</sub>	$V_{CE}$ =2V, $I_c$ =20mA $R_L$ =100 $\Omega$ , -3dB	I	7	-	kHz
	Rise time	tı <sup>.</sup>	V <sub>CE</sub> =2V, I <sub>c</sub> =20mA	-	100	300	μS
	Fall time	$t_f$	$R_L=100\Omega$	-	20	100	$\mu$ s

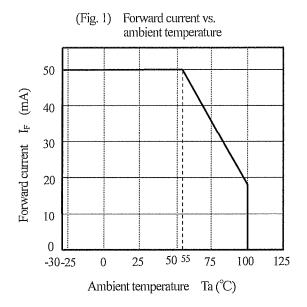
<sup>\*</sup>I The denating factors of absolute maximum ratings due to ambient temperature are shown in Fig. 1 to 4.

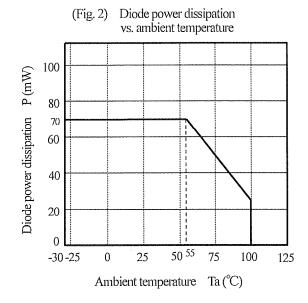
<sup>\*2</sup> Pulse width  $\leq$  100  $\mu$  s, Duty ratio : 0.001 (Refer to Fig. 5)

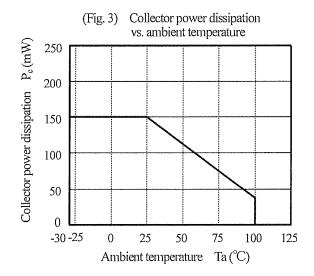
<sup>\*3</sup> AC for 1 min, 40 to 60%RH

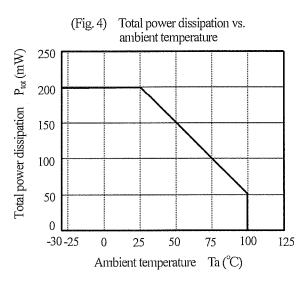
<sup>\*4</sup> For 10 s

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(Fig. 5) Peak forward current vs. duty ratio Pulse width ≤ 100 µs Ta = 25℃ Peak forward current IFM (mA) 2000 1000 500 200 100 50 20 10 10 -3 10 -2 10-1 10° Duty ratio



#### 4. Reliability

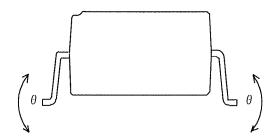
The reliability of products shall satisfy items listed below.

Confidence level: 90%

LTPD: 10or20

			11TD . 1001Z0
Test Items	Condition	Failure Judgment Criteria	Samples (n) Defective (C)
Solderability	245±3℃, 5s	*2	n=11, C=0
Soldering heat	(Flow soldering) 270°C, 10 s		n=11, C=0
Soldering near	(Soldering by hand) 400°C, 3 s		n=11, C=0
Terminal strength (Tension)	Weight: 5N 5 s/each terminal	$V_F$ $>U\times1.2$ $I_R$ $>U\times2$	n=11, C=0
Terminal strength (Bending) *3	Weight: 2.5N 2 times/each terminal	I <sub>CEO</sub> >U×2	n=11, C=0
Mechanical shock	$15 \text{km/s}^2$ , 0.5ms $3 \text{ times/} \pm X$ , $\pm Y$ , $\pm Z$ direction	$\begin{array}{c c} & I_{C} & < L \times 0.7 \\ & V_{CE(sat)} > U \times 1.2 \end{array}$	n=11, C=0
Variable frequency vibration	100 to 2000 to 100Hz/4 min 200m/s <sup>2</sup> 4 times/X, Y, Z direction		n=11, C=0
Temperature cycling	1 cycle −55 °C to +125 °C (30 min) (30 min) 20 cycles test	U: Upper specification limit  L: Lower specification limit	n=22, C=0
High temp. and high Humidity storage	+85°C, 85%RH, 1000h	L. Lower specification mint	n=22, C=0
High temp. storage	+125 °C, 1000h		n=22, C=0
Low temp. storage	-55 °C, 1000h		n=22, C=0
Operation life	I <sub>F</sub> =50mA, P <sub>tot</sub> =200mW Ta=25 °C, 1000h		n=22, C=0

- \*1 Test method, conforms to EIAJ ED 4701.
- \*2 The product whose not-soldered area is more than 5% for all of the dipped area, and/or whose pinholes or voids are concentrated on one place shall be judged defect.
- \*3 Terminal bending direction is shown below.



# REFERENCE CE

#### 5. Outgoing inspection

- 5.1 Inspection items
- $\begin{array}{ccc} \text{(1)} & \text{Electrical characteristics} \\ & V_{F}, I_{R}, I_{CEO}, V_{CE(sut)}, I_{c}, R_{ISO}, V_{iso} \end{array}$
- (2) Appearance

#### 5.2 Sampling method and Inspection level

A single sampling plan, normal inspection level II based on ISO 2859 is applied. The AQL according to the inspection items are shown below.

Defect	Inspection item	AQL(%)
Major defect	Electrical characteristics Unreadable marking	0.065
Minor defect	Appearance defect except the above mentioned.	0.25

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#### 6.2 Package specifications

#### 6.2.1 Taping conditions

(1) Tape structure and Dimensions (Refer to the attached sheet, Page 9)

The carrier tape has the heat pressed structure of PS material carries tape and three layers cover tape (PET material base).

- (2) Reel structure and Dimensions (Refer to the attached sheet, Page 10) The taping reel shall be of plastic (PS material).
- (3) Direction of product insertion (Refer to the attached sheet, Page 10)
- (4) Joint of tape

The cover tape and carrier tape in one reel shall be joint less.

(5) To repair failure-taped devices, cutting a bottom of carrier tape with a cutter. After replacing the cut portion shall be sealed with adhesive tape.

#### 6.2.2 Adhesiveness of cover tape

• The exfoliation force between carrier tape and cover tape shall be 0.2N to 0.7N for the angle  $160^{\circ}$  to  $180^{\circ}$ .

#### 6.2.3 Rolling method and quantity

• Wind the tape back on the reel so that the cover tape will be outside the tape.

Attach more than 20cm of blank tape to the trailer and the leader of the and fix the both ends with adhesive tape.

One reel basically shall contain 2000pcs.

#### 6.2.4 Outer packing appearance

· Refer to the attached sheet, page 10.

#### 6.2.5 Marking

- The label with following information shall be pasted at appointed place of the outer packing case.
  - \* Model No. \*(Business dealing name) \* Lot No. \* Quantity
  - \*Country of origin \*Company name \*Inspection date specified

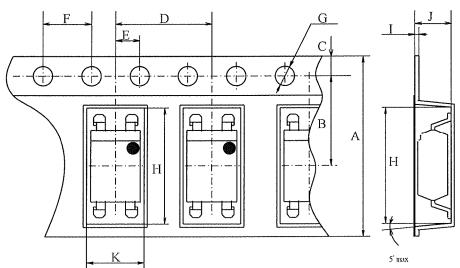
#### 6.2.6 Storage condition

• Taped products shall be stored at the temperature between 5 to  $30^{\circ}$ C and the humidity 70%RH or less away from direct sunlight.

#### 6.2.7 Safety protection during shipping

· There shall be no deformation of component or degradation of electrical characteristics due to shipping.

#### Carrier tape structure and Dimensions

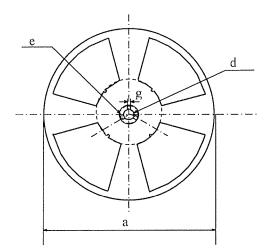


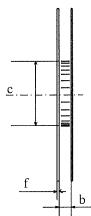
Dimensions list (Unit: mm)

Α	В	С	D	Е	F	G	Н	I	J	K
-						+0.1				
±0.3	±0.1	士0.10	±0.1	±0.1	±0.1	-0.0	±0.1	$\pm 0.05$	±0.1	$\pm 0.1$
16.0	7.5	1.75	8.0	2.0	4.0	$\phi$ 1.5	10.4	0.40	4.2	5.1

# REFERENCE

#### Reel structure and Dimensions

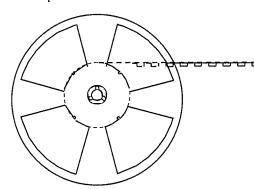


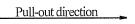


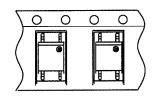
Din	nensions lis	t	(Unit : mm)	

a	b	С	d
(330)	17.5±1.5	φ 100.0±1.0	$\phi$ 13.0 $\pm$ 0.5
e	f	g	
φ23.0±1.0	2.0±0.5	2.0±0.5	

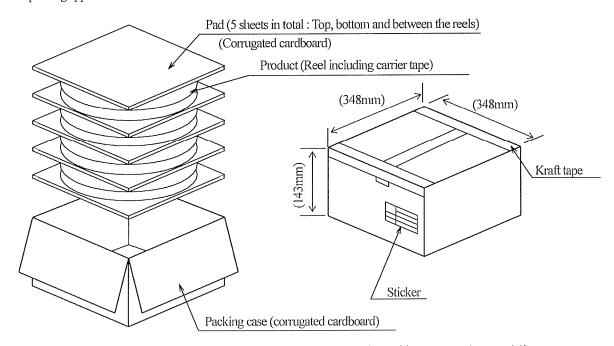
#### Direction of product insertion







#### Outer packing appearance



Regular packing mass: Approx. 4.1kg



#### Precautions for Photocouplers

#### 1 Cleaning

(1) Solvent cleaning: Solvent temperature 45°C or less

Immersion for 3 min or less

(2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output,

cleaning time, PCB size or device mounting condition etc. Please test it in actual using condition

and confirm that any defect doesn't occur before starting the ultrasonic cleaning.

(3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

When the other solvent is used, there are cases that the packaging resin is eroded.

Please use the other solvent after thorough confirmation is performed in actual using condition.

#### 2. Circuit design

The LED used in the Photocoupler generally decreases the light emission power by operation.
 In case of long operation time, please design the circuit in consideration of the degradation of the light emission power of the LED. (50%/5years)

(2) There are cases that the deviation of the CTR and the degradation of the relative light emission power of the LED increase when the setting value of I<sub>F</sub> is less than 1.0mA. Please design the circuit in consideration of this point.

#### 3. Precautions for Soldering

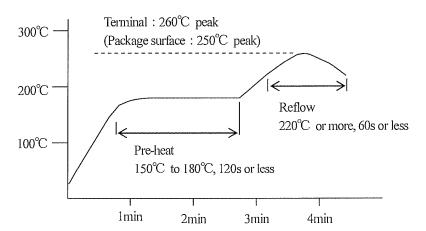
(1) In the case of flow soldering (Whole dipping is possible.)

It is recommended that flow soldering should be at 270°C or less for 10 s or less (Pre-heating: 100 to 150°C, 30 to 80s).

(2 times or less)

(2) If solder reflow:

It is recommended to be done at the temperature and the time within the temperature profile as shown in the figure below. (2 times or less)



#### (3) In the case of hand soldering

What is done on the following condition is recommended. (2 times or less)

Soldering iron temperature: 400°C or less

Time: 3s or less

#### (4) Other precautions

Depending on equipment and soldering conditions (temperature, Using solder etc.),

the effect to the device and the PCB is different.

Please confirm that there is no problem on the actual use conditions in advance

## REFESTING CE

- 1. This specification shall be applied to photocoupler, Model No. PC852 as an option.
- 2. Applicable Models (Business dealing name) PC852XNYIP0F

3. The relevant models are the models Approved by VDE according to DIN EN 60747-5-2.

Approved Model No.: PC852

VDE approved No.: 40008087 (According to the specification DIN EN 60747-5-2)

· Operating isolation voltage

U<sub>IORM</sub>

: 890V<sub>(Peak)</sub>

· Transient voltage

: 9000V (Peak)

Pollution

· Clearances distance (Between input and output) · Creep age distance (Between input and output)

6.4 mm (MIN.) : 6.4 mm (MIN.)

· Isolation thickness between input and output

: 0.15mm (MIN.)

Tracking-proof

CTI 175

· Safety limit values

Current (Isi)

200mA (Diode side)

Power (Psi)

300mW (Phototransistor side)

Temperature (Tsi) : 150°C

In order to keep safety electric isolation of photocoupler, please set the protective circuit to keep within safety limit values when the actual application equipment troubled.

Indication of VDE approval "



" is printed on minimum unit package.

Outline

Refer to the attachment-2-2.

Isolation specification according to EN 60747-5-2.

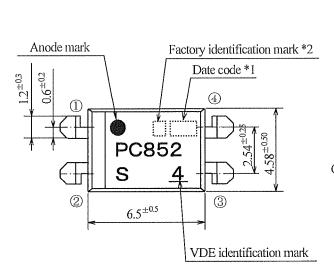
Parameter	Symbol	Condition	Rating	Unit	Remark
Class of environmental test	-		55/110/21	_	
Pollution	-	-	2	_	
Maximum operating isolation voltage	U <sub>IORM</sub> (PEAK)	-	890	V	
Partial discharge test voltage (Between input and output)					Refer to
Diagram 1	Upr	tp=10s, qc<5pC	1340	V	the Diagram 1,2
Diagram 2	(PEAK)	tp=1s, qc<5pC	1670	V	(Attachement-2-3)
Maximum over-voltage	U <sub>IOTM</sub> (PEAK)	t <sub>[N]</sub> =60 s	9000	V	
Safety maximum ratings					7.6
1) Case temperature	Tsi	I <sub>F</sub> =0, P <sub>C</sub> =0,	150	°C	Refer to the Fig. 6,7 (Attachement-2-3)
2) Input current	Isi	Pc=0	200	mA	
3) Electric power (Output or Total power dissipation)	Psi	-	300	mW	
Isolation resistance (Test voltage between input and output; DC500V)	R <sub>ISO</sub>	Ta=Tsi	MIN.10 <sup>9</sup>	Ω	
		Ta=Topr(MAX.)	MIN.10 <sup>11</sup>		
		Ta=25°C	MIN.10 <sup>12</sup>		

- 6. Precautions in performing isolation test
  - 6.1 Partial discharge test methods shall be the ones according to the specifications of EN 60747-5-2
  - 6.2 Please don't carry out isolation test (V<sub>iso</sub>) over U<sub>IOTM</sub>. This product deteriorates isolation characteristics by partial discharge due to applying high voltage (ex. U<sub>IOTM</sub>).

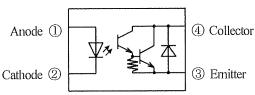
And there is possibility that partial discharge occurs in operating isolation voltage. (U<sub>IORM</sub>).

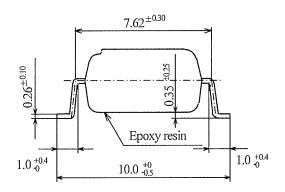
## REFESSIVENCE

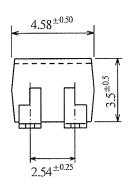
#### 4. Outline



Pin-Number and internal connection diagram







- \*I) 2-digit number shall be marked according to OLD DIN standard
- \*2) Factory identification mark applies to the below.

Notice of the definition mark applies to the below.

Notice of the below.

: WUXI WONDERFUL ELECTRONICS CO., LTD. (China).

or \

: SUN-S Electronic Technology (KUNSHAN) Co., Ltd (China)

Pin material: Copper Alloy

Pin finish: SnCu plating (Cu: TYP. 2%)

Product mass: Approx. 0.22 g

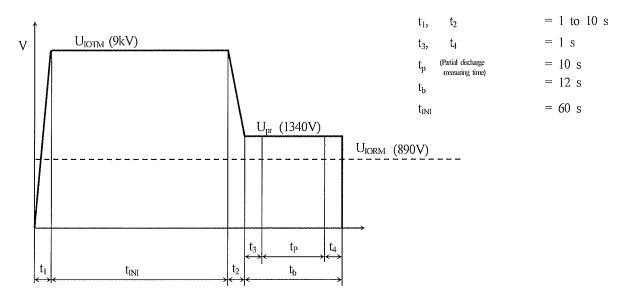
Marking is laser marking

UNIT : 1/1 mm

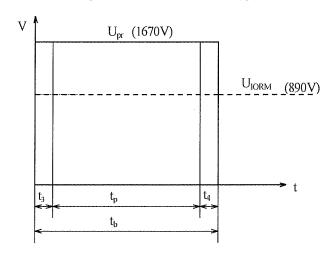
Name Outline Dimensions PC852
(Business dealing name : PC852XNYIP0F)

## REFERENCE

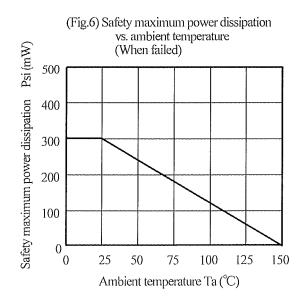
Method of Diagram 1: Breakdown test (Apply to type test and sampling test)

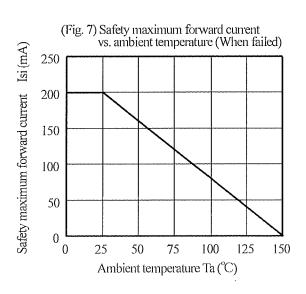


Method of Diagram 2: Non breakdown test (Apply to all device test)



$$\begin{array}{lll} t_3, & t_4 & = 0.1 \text{ s} \\ t_p & \text{(Partial discharge measuring time)} & = 1 \text{ s} \\ t_b & = 1.2 \text{ s} \end{array}$$





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